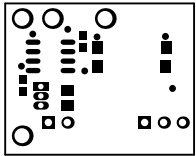
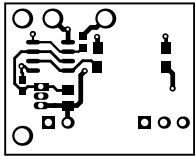


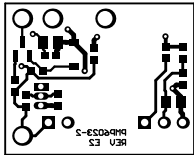
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-2	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 8/14/2014 2:03:11 PM	TEXAS INSTRUMENTS	



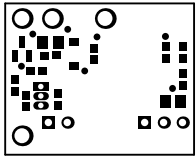
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-2	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 8/14/2014 2:03:13 PM	TEXAS INSTRUMENTS	



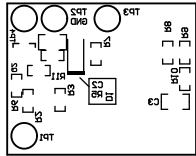
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-2	REV: E2	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Top Layer	GENERATED : 8/14/2014 2:03:14 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-2	REV: E2	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Bottom Layer	GENERATED : 8/14/2014 2:03:15 PM	TEXAS INSTRUMENTS	

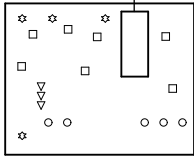


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-2	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 8/14/2014 2:03:17 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-2	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 8/14/2014 2:03:18 PM	TEXAS INSTRUMENTS	

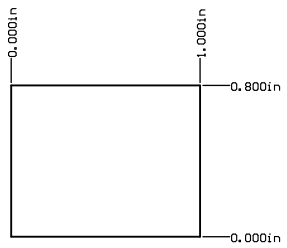
PLACE MFGRS LOGO, UL FLAMMABILITY RATING, Tg TEMP, UL FILE NO AND
DATE CODE HERE IN BOTTOM SILKSCREEN



Symbol	Hit Count	Tool Size	Plated	Hole Type
□	7	16mil (0.406mm)	PTH	Round
▽	3	29.528mil (0.75mm)	PTH	Round
○	5	39.37mil (1mm)	PTH	Round
✱	4	80.709mil (2.05mm)	PTH	Round
19 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-2	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 8/14/2014 2:03:20 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-2	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 8/14/2014 2:03:21 PM	TEXAS INSTRUMENTS	

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